

## N-Channel Depletion-Mode MOSFET Transistors

### Product Summary

| Part Number | $V_{(BR)DSV}$ Min (V) | $r_{DS(on)}$ Max ( $\Omega$ ) | $V_{GS(off)}$ (V) | $I_D$ (A) |
|-------------|-----------------------|-------------------------------|-------------------|-----------|
| ND2012L     | 200                   | 12                            | -1.5 to -4        | 0.16      |
| ND2020L     |                       | 20                            | -0.5 to -2.5      | 0.132     |

### Features

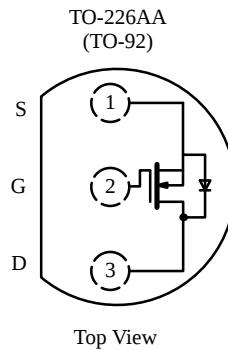
- High Breakdown Voltage: 220 V
- Normally “On” Low  $r_{DS}$  Switch: 9  $\Omega$
- Low Input and Output Leakage
- Low-Power Drive Requirement
- Low Input Capacitance

### Benefits

- Full-Voltage Operation
- Low Offset Voltage
- Low Error Voltage
- Easily Driven Without Buffer
- High-Speed Switching

### Applications

- Normally “On” Switching Circuits
- Current Sources/Limiters
- Power Supply, Converter Circuits
- Solid-State Relays
- Telecom Switches



### Absolute Maximum Ratings ( $T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

| Parameter                                              |                           | Symbol         | ND2012L    | ND2020L  | Unit               |
|--------------------------------------------------------|---------------------------|----------------|------------|----------|--------------------|
| Drain-Source Voltage                                   |                           | $V_{DS}$       | 200        | 200      | V                  |
| Gate-Source Voltage                                    |                           | $V_{GS}$       | $\pm 30$   | $\pm 30$ |                    |
| Continuous Drain Current ( $T_J = 150^\circ\text{C}$ ) | $T_A = 25^\circ\text{C}$  | $I_D$          | 0.16       | 0.132    | A                  |
|                                                        | $T_A = 100^\circ\text{C}$ |                | 0.1        | 0.083    |                    |
| Pulsed Drain Current <sup>a</sup>                      |                           | $I_{DM}$       | 0.8        | 0.8      | W                  |
| Power Dissipation                                      | $T_A = 25^\circ\text{C}$  | $P_D$          | 0.8        | 0.8      |                    |
|                                                        | $T_A = 100^\circ\text{C}$ |                | 0.32       | 0.32     |                    |
| Maximum Junction-to-Ambient                            |                           | $R_{thJA}$     | 156        | 156      | $^\circ\text{C/W}$ |
| Operating Junction and Storage Temperature Range       |                           | $T_J, T_{stg}$ | -55 to 150 |          | $^\circ\text{C}$   |

#### Notes

a. Pulse width limited by maximum junction temperature.

Updates to this data sheet may be obtained via facsimile by calling Siliconix FaxBack, 1-408-970-5600. Please request FaxBack document #70197. Applications information may also be obtained via FaxBack, request document #70612.

# ND2012L/2020L

## Specifications<sup>a</sup>

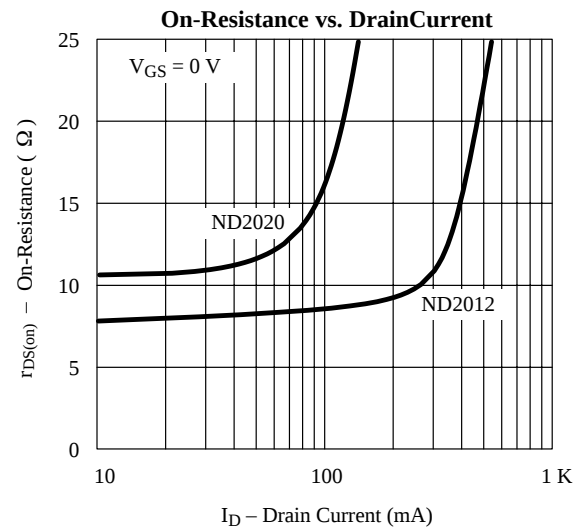
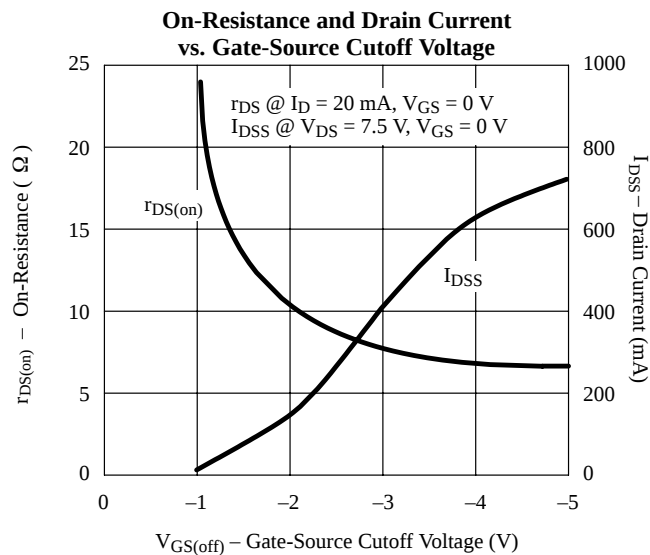
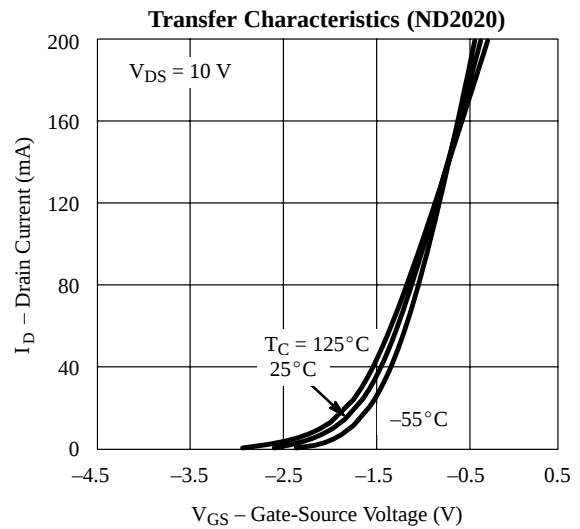
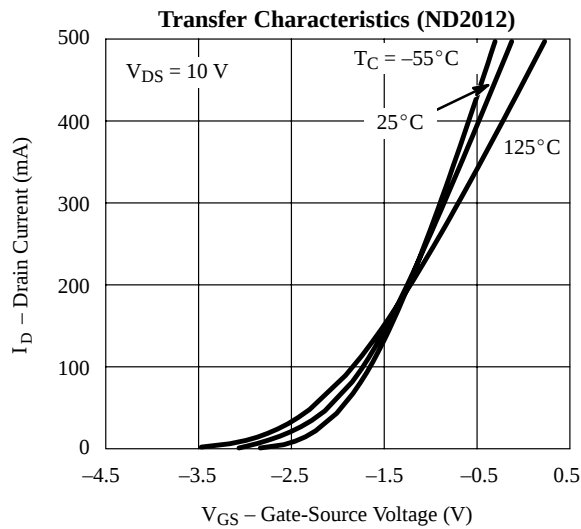
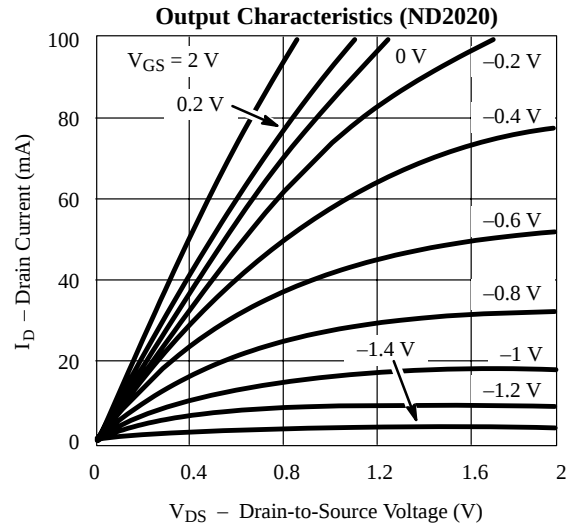
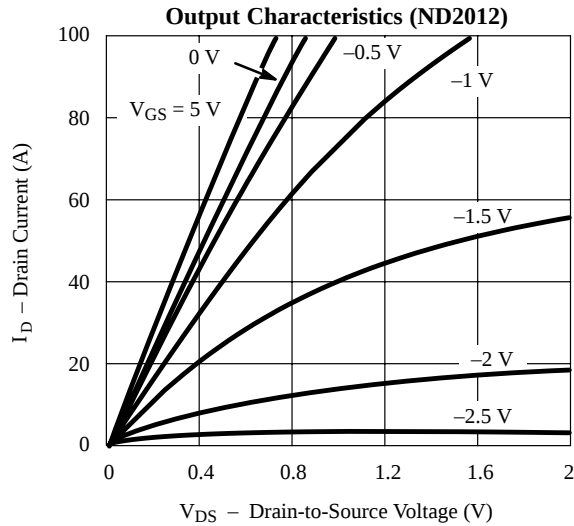
| Parameter                                     | Symbol               | Test Conditions                                                                                                             | Typ <sup>b</sup> | Limits  |     |         |      | Unit |
|-----------------------------------------------|----------------------|-----------------------------------------------------------------------------------------------------------------------------|------------------|---------|-----|---------|------|------|
|                                               |                      |                                                                                                                             |                  | ND2012L |     | ND2020L |      |      |
|                                               |                      |                                                                                                                             |                  | Min     | Max | Min     | Max  |      |
| Static                                        |                      |                                                                                                                             |                  |         |     |         |      |      |
| Drain-Source Breakdown Voltage                | V <sub>(BR)DSV</sub> | V <sub>GS</sub> = −8 V, I <sub>D</sub> = 10 μA                                                                              | 220              | 200     |     |         |      | V    |
|                                               |                      | V <sub>GS</sub> = −5 V, I <sub>D</sub> = 10 μA                                                                              | 220              |         |     | 200     |      |      |
| Gate-Source Cutoff Voltage                    | V <sub>GS(off)</sub> | V <sub>DS</sub> = 5 V, I <sub>D</sub> = 10 μA                                                                               |                  | −1.5    | −4  | −0.5    | −2.5 |      |
| Gate-Body Leakage                             | I <sub>GSS</sub>     | V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ±20 V                                                                              |                  |         | ±10 |         | ±10  | nA   |
|                                               |                      | T <sub>J</sub> = 125°C                                                                                                      |                  |         | ±50 |         | ±50  |      |
| Drain Cutoff Current                          | I <sub>D(off)</sub>  | V <sub>DS</sub> = 160 V, V <sub>GS</sub> = −8 V                                                                             |                  |         | 1   |         |      | μA   |
|                                               |                      | T <sub>J</sub> = 125°C                                                                                                      |                  |         | 200 |         |      |      |
|                                               |                      | V <sub>DS</sub> = 160 V, V <sub>GS</sub> = −5 V                                                                             |                  |         |     |         | 1    |      |
|                                               |                      | T <sub>J</sub> = 125°C                                                                                                      |                  |         |     |         | 200  |      |
| Drain-Saturation Current <sup>c</sup>         | I <sub>DSS</sub>     | V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V                                                                               | 300              | 30      |     | 30      |      | mA   |
| Drain-Source On-Resistance <sup>c</sup>       | r <sub>DS(on)</sub>  | V <sub>GS</sub> = 2 V, I <sub>D</sub> = 20 mA                                                                               | 7                |         |     |         |      | Ω    |
|                                               |                      | V <sub>GS</sub> = 0 V, I <sub>D</sub> = 20 mA                                                                               | 8                |         | 12  |         | 20   |      |
|                                               |                      | T <sub>J</sub> = 125°C                                                                                                      | 12.6             |         | 30  |         | 50   |      |
| Forward Transconductance <sup>c</sup>         | g <sub>fs</sub>      | V <sub>DS</sub> = 7.5 V, I <sub>D</sub> = 20 mA                                                                             | 55               |         |     |         |      | mS   |
| Common Source Output Conductance <sup>c</sup> | g <sub>os</sub>      |                                                                                                                             | 75               |         |     |         |      | μS   |
| Dynamic                                       |                      |                                                                                                                             |                  |         |     |         |      |      |
| Input Capacitance                             | C <sub>iss</sub>     | V <sub>DS</sub> = 25 V, V <sub>GS</sub> = −5 V, f = 1 MHz                                                                   | 35               |         | 100 |         | 100  | pF   |
| Output Capacitance                            | C <sub>oss</sub>     |                                                                                                                             | 10               |         | 20  |         | 20   |      |
| Reverse Transfer Capacitance                  | C <sub>rss</sub>     |                                                                                                                             | 2                |         | 5   |         | 5    |      |
| Switching <sup>d</sup>                        |                      |                                                                                                                             |                  |         |     |         |      |      |
| Turn-On Time                                  | t <sub>d(on)</sub>   | V <sub>DD</sub> = 25 V, R <sub>L</sub> = 1250 Ω<br>I <sub>D</sub> ≅ 20 mA, V <sub>GEN</sub> = −5 V<br>R <sub>G</sub> = 25 Ω | 20               |         |     |         |      | ns   |
|                                               | t <sub>r</sub>       |                                                                                                                             | 20               |         |     |         |      |      |
| Turn-Off Time                                 | t <sub>d(off)</sub>  |                                                                                                                             | 10               |         |     |         |      |      |
|                                               | t <sub>f</sub>       |                                                                                                                             | 10               |         |     |         |      |      |

### Notes

- $T_A = 25^\circ\text{C}$  unless otherwise noted.
- For DESIGN AID ONLY, not subject to production testing.
- Pulse test:  $PW \leq 300\text{ }\mu\text{s}$  duty cycle  $\leq 2\%$ .
- Switching time is essentially independent of operating temperature.

VDDQ20

## Typical Characteristics (25°C Unless Otherwise Noted)



## Typical Characteristics (25°C Unless Otherwise Noted) (Cont'd)

